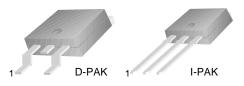


MJD45H11

General Purpose Power and Switching Such as Output or Driver Stages in Applications D-PAK for Surface Mount Applications

- Load Formed for Surface Mount Application (No Suffix)
- Straight Lead (I-PAK: "-I" Suffix)
- Electrically Similar to Popular MJE45H
- · Fast Switching Speeds
- Low Collector Emitter Saturation Voltage



1.Base 2.Collector 3.Emitter

PNP Epitaxial Silicon Transistor

Absolute Maximum Ratings T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	- 80	V
V _{EBO}	Emitter-Base Voltage	- 5	V
I _C	Collector Current (DC)	- 8	Α
I _{CP}	Collector Current (Pulse)	- 16	Α
P _C	Collector Dissipation (T _C =25°C)	20	W
	Collector Dissipation (T _a =25°C)	1.75	W
TJ	Junction Temperature	150	°C
T _{STG}	Storage Temperature	- 55 ~ 150	°C

Electrical Characteristics T_C=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V _{CEO} (sus)	*Collector-Emitter Sustaining Voltage	$I_C = -30 \text{mA}, I_B = 0$	- 80			V
I _{CEO}	Collector Cut-off Current	$V_{CE} = -80V, I_{B} = 0$			- 10	μΑ
I _{EBO}	Emitter Cut-off Current	$V_{BE} = -5V, I_{C} = 0$			- 50	μΑ
h _{FE}	*DC Current Gain	$V_{CE} = -1V, I_{C} = -2A$	60			
		$V_{CE} = -1V, I_{C} = -4A$	40			
V _{CE} (sat)	*Collector-Emitter Saturation Voltage	$I_C = -8A, I_B = -0.4A$			- 1	V
V _{BE} (on)	*Base-Emitter Saturation Voltage	$I_C = -8A, I_B = -0.8A$			- 1.5	V
f _T	Current Gain Bandwidth Product	$V_{CE} = -10A, I_{C} = -0.5A$		40		MHz
C _{ob}	Collector Capacitance	V _{CB} = - 10V, f = 1MHz		230		pF
t _{ON}	Turn On Time	I _C = - 5A		135		ns
t _{STG}	Storage Time	$I_{B1} = -I_{B2} = -0.5A$		500		ns
t _F	Fall Time			100		ns

^{*} Pulse Test: PW≤300μs, Duty Cycle≤2%

Typical Characteristics

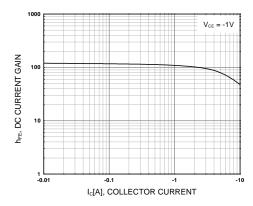


Figure 1. DC current Gain

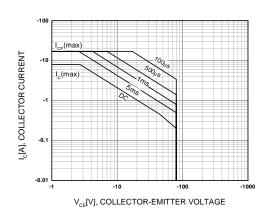


Figure 2. Safe Operating Area

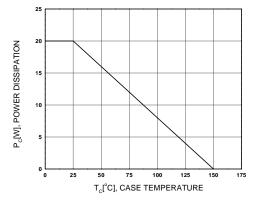
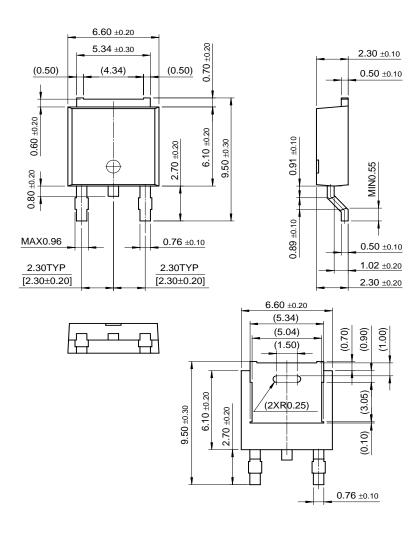


Figure 3. Power Derating

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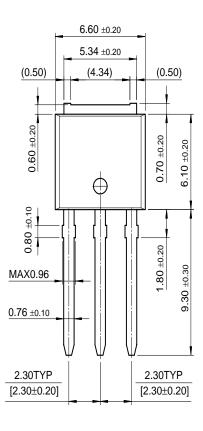
Package Dimensions

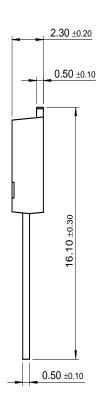
D-PAK



Package Dimensions (Continued)

I-PAK







Dimensions in Millimeters

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E ² CMOS TM	HiSeC™	MSXPro™	Quiet Series™	TruTranslation™
EnSigna™	I ² C TM	OCX™	RapidConfigure™	UHC™
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The Power Franchise™		OPTOLOGIC [®]	SILENT SWITCHER®	VCX^{TM}
Programmable Active Droop™		OPTOPLANAR™	SMART START™	

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